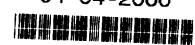
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ER SHEET

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hed original documents or copy thereof

To the Honorable Commissioner of Latan.	Indu disginar addaments or copy thereof	
Name of conveying party(ies):	Name and address of receiving party(ies):	
Max F. Hineman	Name: Micron Technology, Inc.	
Additional name(s) of conveying Party(ies) attached? X No 3. Nature of Conveyance:	Internal Address: Street Address: 8000 S. Federal Way	
l <u> </u>	City: Poins	
X Assignment Merger	City: Boise	
Security Agreement Change of Name	State: <u>Idaho</u> Zip: <u>83706-9632</u>	
Other	Country: USA	
Execution Date(s): 3/7/00	Additional name(s) & Yes address(es) attached? X No	
4. Application number(s) or patent number(s):		
If this document is being filed together with a new applic the Execution date(s) of the new application is (are):	ation, 3/7/00	
A. Patent Application No.(s):	B. Patent No.(s):	
5. Name and address of party to whom correspondence concerning document should be mailed:	Additional numbers attached? Yes X No 6. Total number of applications and patents involved:	
Name: DICKSTEIN SHAPIRO MORIN & OSHINSKY LLP	7. Total fee (37 C.F.R 3.41) \$ \$40.00	
Internal Address: Atty. Dkt.: M4065.0211/P211	x Enclosed	
Attn: Thomas J. D'Amico	Authorized to be charged to deposit account	
Street Address: 2101 L Street NW	x Credit any overpayment or debit any underpayment	
City: State: Zip: Washington DC 20037 - 1526	8. Deposit account number: 4 - 1073	
DO NOT USE THIS SPACE		
9. Statement and signature.		
To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.		
Thomas J. D'Amico	March 23, 2000	
Signature	Date	
Reg. No. 28,371		
Total number of pages including cover sheet, attachments, and document: 3		

1126295 v1; _51Z01!.DOC

Docket No.: M4065.0211/P211 Micron No.: 98-1028

ASSIGNMENT AND AGREEMENT

For value received, I, Max F. Hineman, hereby sell, assign and transfer to Micron Technology, Inc., a corporation of the State of Delaware, having an office at 8000 S. Federal Way, Boise, Idaho 83706-9632, U.S.A., and its successors, assigns and legal representatives, the entire right, title and interest, for the United States of America, in and to certain inventions related to an invention entitled METHOD FOR FORMING A SILICIDE GATE STACK FOR USE IN A SELF-ALIGNED CONTACT ETCH, described in an application for Letters Patent of the United States, executed by me of even date herewith, and all the rights and privileges in said application and under any and all Letters Patent that may be granted in the United States for said inventions; and I also concurrently hereby sell, assign and transfer to Micron Technology, Inc. the entire right, title and interest in and to said inventions for all countries foreign to the United States, including all rights of priority arising from the application aforesaid, and all the rights and privileges under any and all forms of protection, including Letters Patent, that may be granted in said countries foreign to the United States for said inventions.

I authorize Micron Technology, Inc. to make application for such protection in its own name and maintain such protection in any and all countries foreign to the United States, and to invoke and claim for any application for patent or other form of protection for said inventions, without further authorization from me, any and all benefits, including the right of priority provided by any and all treaties, conventions, or agreements.

I hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country in proof of the right of Micron Technology, Inc. to apply for patent or other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

I request that any and all patents for said inventions be issued to Micron Technology, Inc. in the United States and in all countries foreign to the United States, or to such nominees as Micron Technology, Inc. may designate.

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PATENT REEL: 010647 FRAME: 0404

Docket No.: M4065.0211/P211 Micron No.: 98-1028

I agree that, when requested, I shall, without charge to Micron Technology, Inc. but at its expense, sign all papers, and do all acts which may be necessary, desirable or convenient in connection with said applications, patents, or other forms of protection.

Date: 3 7 00	Max F. Hineman
United States of America)
State of Odaho)ss.:
County of <u>Oda</u>)
On this day of	March, 200 , before me
personally came <u>Max F. Hineman</u>	, to me known to be the
	ted the foregoing instrument, and acknowledged
execution of the same.	1
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RECORDED: 03/23/2000

PATENT REEL: 010647 FRAME: 0405